

Applicants	: Masaru SHIRAI et al.	Group Art Unit : 1793
Appl. No.	: 10/598,142 (U.S. National Stage of PCT/JP2005/005909)	Examiner : Nicholas D'ANIELLO
I.A. Filed	: March 17, 2005	Confirmation No. : 1550
For	: HEATER, REFLOW APPARATUS, AND SOLDER BUMP FORMING METHOD AND APPARATUS	

Commissioner for Patents
U.S. Patent and Trademark Office
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In response to the Official Action dated June 3, 2010, setting a shortened three-month statutory period for response to expire on September 3, 2010, Applicants respectfully request reconsideration and withdrawal of the outstanding rejections in view of the herein-contained amendments and remarks. However, if any extension of time is necessary, this is an express request for any necessary extension of time and authorization to charge any required extension of time fee or any other fees which may be required to preserve the pendency of the present application to Deposit Account No. 19-0089.

Amendments to the Claims begin on page 2 of this document.
Remarks begin on page 9 of this document.